

T1035H, T1050H

Main characteristics

Symbol	Value	Unit
I _{T(RMS)}	10	A
V_{DRM}/V_{RRM}	600	V
I _{GT}	35 or 50	mA

Features

- Medium current Triac
- 150° C max. T_i turn-off commutation
- Low thermal resistance with clip bonding
- Very high 3 quadrant commutation capability
- Packages are RoHS (2002/95/EC) compliant

Applications

Especially designed to operate in high power density or universal motor applications such as vacuum cleaner and washing machine drum motor, these 10 A triacs provide a very high switching capability up to junction temperatures of 150° C.

The heatsink can be reduced, compared to traditional triacs, according to the high performance at given junction temperatures.

Description

Available in through-hole or surface mount packages, the T1035H and T1050H triac series are suitable for general purpose mains power AC switching.

High temperature 10 A Triacs



Order codes

Part Numbers	Marking
T1035H-6G	T1035H 6G
T1050H-6G	T1050H 6G
T1035H-6G-TR	T1035H 6G
T1050H-6G-TR	T1050H 6G
T1035H-6T	T1035H 6T
T1050H-6T	T1050H 6T
T1035H-6I	T1035H 6I
T1050H-6I	T1050H 6I

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1 Characteristics

Symbol	Param	Value	Unit			
1	DMS on state current (full sine ways)	D ² PAK, TO-220AB	T _c = 135° C	10	^	
I _{T(RMS)}	RMS on-state current (full sine wave)	TO-220AB Ins $T_c = 125^{\circ} C$		10	A	
	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	100	Α	
ITSM	current (full cycle, T_j initial = 25° C)	F = 60 Hz	t = 16.7 ms	105	А	
l ² t	I ² t Value for fusing	t _p = 10 ms	66	A ² s		
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , t_r \leq 100 ns	F = 120 Hz $T_j = 150^{\circ} C$		50	A/µs	
V _{DSM} /V _{RSM}	Non repetitive surge peak off-state voltage	k off-state $t_p = 10 \text{ ms}$ $T_j = 25^{\circ} \text{ C}$		V _{DRM} /V _{RRM} + 100	V	
I _{GM}	Peak gate current $t_p = 20 \ \mu s$ $T_j = 150^\circ C$		4	А		
P _{G(AV)}	Average gate power dissipation	1	W			
T _{stg} T _j	Storage junction temperature range Operating junction temperature range	- 40 to + 150 - 40 to + 150	°C			

Table 1. Absolute Maximum Ratings

Table 2.Electrical Characteristics ($T_j = 25^\circ C$, unless otherwise specified)

Symbol	Symbol Test Conditions	Quadrant		Value		Unit
Symbol				T1035H	T1050H	UIII
I _{GT} ⁽¹⁾	V = 12 V P = 22 O	- -	MAX.	35	50	mA
V _{GT}	V_{GT} $V_{\text{D}} = 12 \text{ V}$ $R_{\text{L}} = 33 \Omega$		MAX.	1.0		V
V _{GD}	$V_{D} = V_{DRM}, R_{L} = 3.3 \text{ k}\Omega \qquad \qquad I - II - III$		MIN.	0.15		V
I _H ⁽²⁾	I _T = 500 mA		MAX.	35	75	mA
1.	I _G = 1.2 I _{GT}	I - III	MAX.	50	90	mA
۱ _L	IG - 1.2 IGT			80	110	
dV/dt ⁽²⁾	$V_D = 67\% V_{DRM,}$ gate open, $T_j = 150^{\circ} C$	MIN.	1000	1500	V/µs	
(dl/dt)c ⁽²⁾	Without snubber, $T_j = 150^{\circ} C$		MIN.	13	18	A/ms

1. minimum $I_{\mbox{GT}}$ is guaranted at 20% of $I_{\mbox{GT}}$ max.

2. for both polarities of A2 referenced to A1.



Symbol	Test Conc	Value	Unit		
$V_{T}^{(1)}$	I _{TM} = 14 A, t _p = 380 μs	$T_j = 25^\circ C$	MAX.	1.5	V
V _{t0} ⁽¹⁾	Threshold voltage	$T_j = 150^\circ C$	MAX.	0.80	V
R _d ⁽¹⁾	Dynamic resistance	$T_j = 150^\circ C$	MAX.	34	mΩ
	V _{DRM} = V _{RRM}	$T_j = 25^\circ C$	MAX.	5	μA
I _{DRM}		T _j = 150° C	MAX.	3.6	
I _{RRM} ⁽²⁾	$V_D/V_R = 400 V$ (at peak mains voltage)	T _j = 150° C	MAX.	3.0	mA
	$V_D/V_R = 200 V$ (at peak mains voltage)	T _j = 150° C	MAX.	2.5	

Table 3.Static Characteristics

1. for both polarities of A2 referenced to A1.

2. t_p = 380 μs

Table 4.Thermal resistance

Symbol	I	Parameter			Value	Unit
Р		lunction to page (AC)		D ² PAK / TO-220AB	1.45	
^н th(j-c)	R _{th(j-c)} Junction to case (AC			TO-220AB Ins	3.4	° C/W
Р		Junction to ambient	$S = 1 \text{ cm}^2$	D ² PAK	45	C/ W
hth(j-a)	R _{th(j-a)} J	Junction to ambient		TO-220AB / TO-220AB Ins	60	

Figure 1. Maximum power dissipation versus Figure 2. RMS on-state current (full cycle)

RMS on-state current versus case temperature (full cycle)



Figure 3. RMS on-state current versus ambient temperature (Epoxy printed circuit board FR4, copper thickness = 35 µm)







Surge peak on-state current versus number of cycles



Figure 7. Non-repetitive surge peak on-state Figure 8. current for a sinusoidal pulse with width $t_p < 10$ ms and corresponding value of I^2t





Figure 9. Relative variation of critical rate of Figure 10. decrease of main current (dl/dt)c versus reapplied (dV/dt)c (typical values)







Figure 12. Variation of thermal resistance junction to ambient versus copper surface under tab (Epoxy printed circuit board FR4, copper thickness = 35 μm)



2 Ordering information



3 Package mechanical data

- Epoxy meets UL94, V0
- Recommended torque 0.4 to 0.6 Nm

Table 5.D²PAK dimensions



Figure 13. Footprint (dimensions in mm)



					Dimer	nsions		
		Ref.	M	illimete	rs		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
		a1		3.75			0.147	
Ø I	C C	a2	13.00		14.00	0.511		0.551
	b2, ↓ ↓	В	10.00		10.40	0.393		0.409
	F	b1	0.61		0.88	0.024		0.034
A		b2	1.23		1.32	0.048		0.051
14 I3		С	4.40		4.60	0.173		0.181
	c2	c1	0.49		0.70	0.019		0.027
		c2	2.40		2.72	0.094		0.107
a2		е	2.40		2.70	0.094		0.106
	M	F	6.20		6.60	0.244		0.259
e ⇒iii b1		ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		13	1.14		1.70	0.044		0.066
		М		2.60			0.102	

Table 6. TO-220AB and TO-220AB Ins dimensions

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.



4 Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
T10xxH-6G	T10xxH 6G	D ² PAK	1.5 g	50	Tube
T10xxH-6G-TR	T10xxH 6G	D ² PAK	1.5 g	1000	Tape and reel
T10xxH-6T	T10xxH 6T	TO-220AB	2.3 g	50	Tube
T10xxH-6I	T10xxH 6I	TO-220AB Ins	2.3 g	50	Tube

5 Revision history

Date	Revision	Description of Changes
17-Apr-2007	1	First issue



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